# **SWITCHMODE**<sup>TM</sup> **Power Rectifier** 80 V, 30 A

#### **Features and Benefits**

- Low Power Loss/High Efficiency
- High Surge Capacity
- 30 A Total (15 A Per Diode Leg)
- These are Pb-Free Devices

#### **Applications**

- Power Supply Output Rectification
- Power Management
- Instrumentation

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Epoxy Meets UL 94 V-0 @ 0.125 in
- Weight: 1.9 Grams (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- ESD Rating: Human Body Model = 3B

Machine Model = C

#### **MAXIMUM RATINGS**

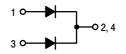
Please See the Table on the Following Page



#### ON Semiconductor®

http://onsemi.com

## **SCHOTTKY BARRIER** RECTIFIER **30 AMPERES** 80 VOLTS

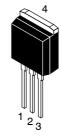




#### **MARKING DIAGRAM**

TO-220AB **CASE 221A** 





I<sup>2</sup>PAK (TO-262) **CASE 418D PLASTIC** STYLE 3

**PLASTIC** 



= Assembly Location

= Year WW = Work Week B30H80 = Device Code = Pb-Free Package = Polarity Designator

#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

#### MAXIMUM RATINGS (Per Diode Leg)

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	80	V
Average Rectified Forward Current (T <sub>C</sub> = 130°C) Per Diode Per Device	I <sub>F(AV)</sub>	15 30	Α
Peak Repetitive Forward Current (Square Wave, 20 kHz, T <sub>C</sub> = 130°C)	I <sub>FM</sub>	30	А
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	240	А
Storage Temperature	T <sub>stg</sub>	-65 to +175	°C
Operating Junction Temperature (Note 1)	T <sub>J</sub>	-20 to +150	°C
ESD Ratings: Machine Model = C Human Body Model = 3B		> 400 > 8000	V

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance  – Junction-to-Case	$R_{ hetaJC}$	2.0	°C/W
<ul><li>Junction-to-Ambient</li></ul>	$R_{ hetaJA}$	70	

#### **ELECTRICAL CHARACTERISTICS** (Per Diode Leg)

Characteristic	Symbol	Min	Тур	Max	Unit
Maximum Instantaneous Forward Voltage (Note 2)	VF				V
(i <sub>F</sub> = 3 A, T <sub>.1</sub> = 25°C)	, i	_	0.49	0.58	
(i <sub>F</sub> = 3 A, T <sub>J</sub> = 25°C)		_	0.37	0.45	
(i <sub>F</sub> = 15 A, T <sub>J</sub> = 25°C)		_	0.65	0.78	
$(i_F = 15 \text{ A}, T_J = 125^{\circ}\text{C})$		_	0.55	0.65	
$(i_F = 30 \text{ A}, T_J = 25^{\circ}\text{C})$		_	0.77	0.88	
$(i_F = 30 \text{ A}, T_J = 125^{\circ}\text{C})$		-	0.67	0.75	
Maximum Instantaneous Reverse Current (Note 2)	i <sub>R</sub>				mA
(Rated DC Voltage, T <sub>J</sub> = 125°C)		_	12	35	
(Rated DC Voltage, T <sub>J</sub> = 25°C)		_	0.017	0.250	

<sup>2.</sup> Pulse Test: Pulse Width = 300  $\mu s, \, \text{Duty Cycle} \leq 2.0\%.$ 

#### **DEVICE ORDERING INFORMATION**

Device Order Number	Package Type	Shipping <sup>†</sup>
MBR30H80CTG	TO-220 (Pb-Free)	50 Units / Rail
MBRB30H80CT-1G	I <sup>2</sup> PAK (Pb-Free)	50 Units / Rail

<sup>1.</sup> The heat generated must be less than the thermal conductivity from Junction-to-Ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ .

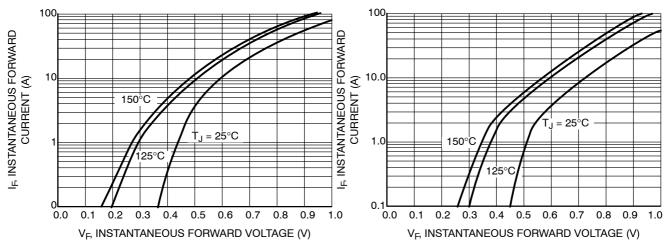
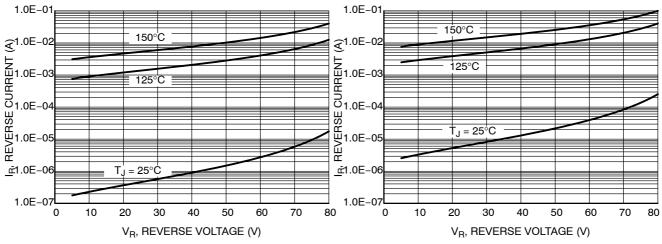


Figure 1. Typical Forward Voltage

Figure 2. Maximum Forward Voltage



**Figure 3. Typical Reverse Current** 

Figure 4. Maximum Reverse Current

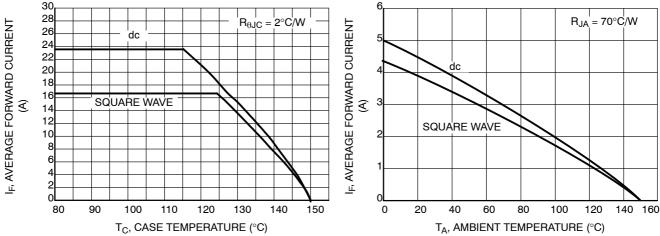
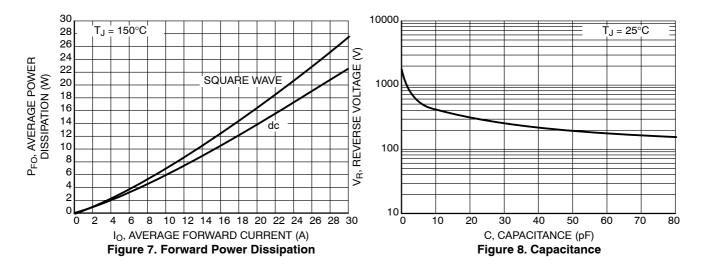


Figure 5. Current Derating, Case per Leg

Figure 6. Current Derating, Ambient per Leg



100 R(t), TRANSIENT THERMAL RESISTANCE D = 0.5 10 0.2 ш 0.1 0.05 0.01 -| t<sub>1</sub> |<del>-</del>< 0.1 DUTY CYCLE,  $D = t_1/t_2$ SINGLE PULSE 0.01 0.000001 0.00001 0.0001 0.01 1000 0.001 0.1 10 100 t<sub>1</sub>, TIME (sec)

Figure 9. Thermal Response Junction-to-Ambient

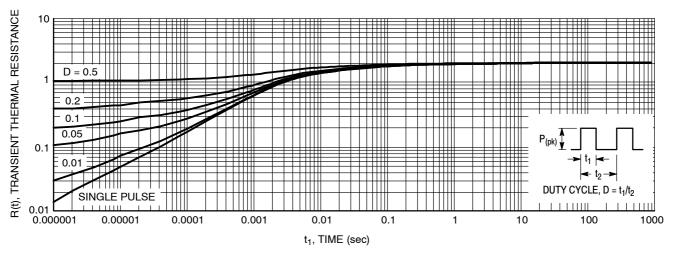
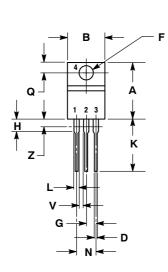
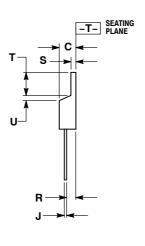


Figure 10. Thermal Response Junction-to-Case

### **PACKAGE DIMENSIONS**

TO-220 CASE 221A-09 **ISSUE AF** 





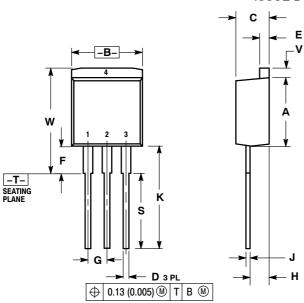
- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.
  3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.570	0.620	14.48	15.75
В	0.380	0.405	9.66	10.28
С	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.161	3.61	4.09
G	0.095	0.105	2.42	2.66
Н	0.110	0.155	2.80	3.93
J	0.014	0.025	0.36	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
٧	0.045		1.15	
Z		0.080		2.04

- STYLE 6:
  PIN 1. ANODE
  2. CATHODE
  3. ANODE
  4. CATHODE

#### PACKAGE DIMENSIONS

#### I<sup>2</sup>PAK (TO-262) CASE 418D-01 ISSUE D



#### NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI
   NAME OF THE PROPERTY OF THE PRO
- 2. CONTROLLING DIMENSION: INCH.

	INCHES		MILLIN	IETERS	
DIM	MIN	MAX	MIN	MAX	
Α	0.335	0.380	8.51	9.65	
В	0.380	0.406	9.65	10.31	
С	0.160	0.185	4.06	4.70	
D	0.026	0.035	0.66	0.89	
E	0.045	0.055	1.14	1.40	
F	0.122 REF		3.10 REF		
G	0.100 BSC		2.54	2.54 BSC	
Н	0.094	0.110	2.39	2.79	
J	0.013	0.025	0.33	0.64	
K	0.500	0.562	12.70	14.27	
S	0.390 REF		9.90	REF	
٧	0.045	0.070	1.14	1.78	
w	0.522	0.551	13 25	14.00	

#### STYLE 3:

PIN 1. ANODE

- 2. CATHODE
- 3 ANODE
- 3. ANODE 4. CATHODE

SWITCHMODE is a trademark of Semiconductor Components Industries, LLC.

ON Semiconductor and are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

#### **PUBLICATION ORDERING INFORMATION**

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor P.O. Box 5163, Denver, Colorado 80217 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada

Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com

N. American Technical Support: 800–282–9855 Toll Free USA/Canada
Europe, Middle East and Africa Technical Support:

Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910 Japan Customer Focus Center

Phone: 81-3-5773-3850

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

# **Mouser Electronics**

**Authorized Distributor** 

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

**ON Semiconductor:** 

MBR30H80CTG MBRB30H80CT-1G